



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	Preven mor	I _D max
Device	DVDSS	R _{DS(ON)} max	$T_A = +25^{\circ}C$
		$0.4\Omega @ V_{GS} = 4.5V$	870mA
Q1	20V	$0.5\Omega @ V_{GS} = 2.5V$	780mA
		0.7Ω @ V _{GS} = 1.8V	640mA
		0.7Ω @ V _{GS} = -4.5V	-640mA
Q2	Q2 -20V	0.9Ω @ V _{GS} = -2.5V	-580mA
		1.3Ω @ V _{GS} = -1.8V	-465mA

Description and Applications

This MOSFET is designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Switches

Features

- Low On-Resistance
- Low Gate Threshold Voltage V_{GS(th)} <1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate to 2.5kV HBM
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

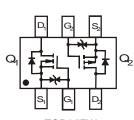
- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)







BOTTOM VIEW



TOP VIEW Internal Schematic

Ordering Information (Note 5)

	Part Number	Case	Packaging		
	DMG1016VQ-7	SOT-563	3,000/Tape & Reel		
	DMG1016VQ-13	SOT-563	10,000/Tape & Reel		
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.				

SOT-563

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

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	C	41	Y	М	
Т					

CA1 = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: W = 2009)

M = Month (ex: 9 = September)

Date	Code	Key
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Year	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020
Code	W	Х	Y	Z	А	В	С	D	E	F	G	Н
	1	1	1		1		1					1
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (Q1 N-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±6	V
Drain Current (Note 6) $T_A = +25^{\circ}$ $T_A = +85^{\circ}$		870 630	mA

Maximum Ratings (Q2 P-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±6	V
Drain Current (Note 6)	T _A = +25°C T _A = +85°C	ID	-640 -460	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	Pn	530	mW
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	235	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C



Electrical Characteristics (Q1 N-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	20	_		V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}			100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}			± 1.0	μA	$V_{GS} = \pm 4.5 V$, $V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	0.5		1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
			0.3	0.4		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	0.4	0.5	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.5	0.7		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance	Y _{fs}		1.4		S	$V_{DS} = 10V, I_D = 400mA$
Diode Forward Voltage (Note 7)	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS						
Input Capacitance	Ciss		60.67		pF	
Output Capacitance	Coss		9.68		pF	V _{DS} = 16V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	5.37		pF	1 = 1.000112
Total Gate Charge	Qg	_	736.6			
Gate-Source Charge	Qgs		93.6		рС	$V_{GS} = 4.5V, V_{DS} = 10V,$ Ip = 250mA
Gate-Drain Charge	Q _{gd}	_	116.6			$I_D = 250IIIA$
Turn-On Delay Time	t _{d(on)}		5.1			
Turn-On Rise Time	tr		7.4	_	nS	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{d(off)}		26.7		115	$R_L = 47\Omega, R_G = 10\Omega,$ $I_D = 200mA$
Turn-Off Fall Time	t _f		12.3			ID = 20011A

Electrical Characteristics (Q2 P-Channel) (@T_A = +25°C, unless otherwise specified.)

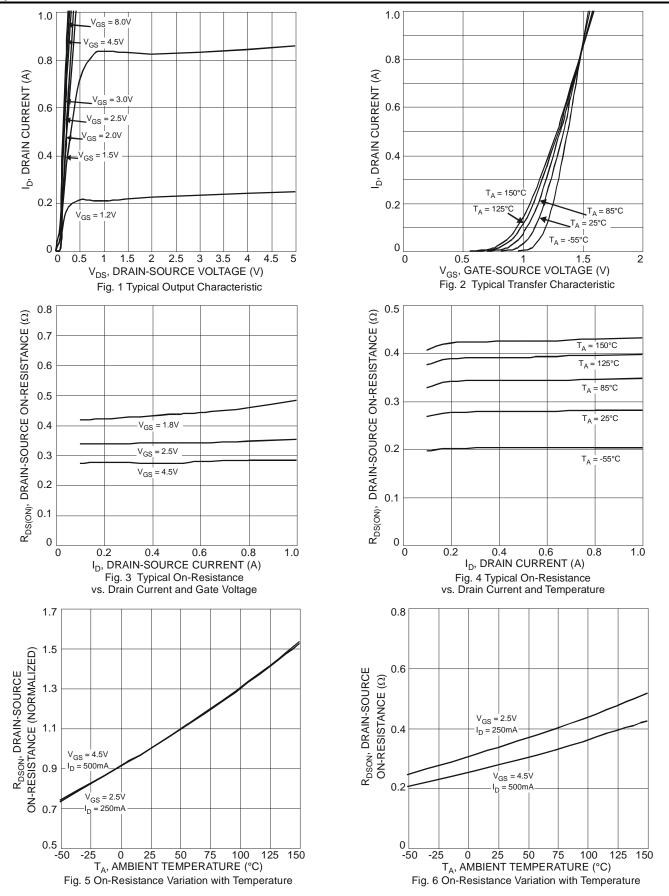
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	± 2.0	μA	$V_{GS} = \pm 4.5 V$, $V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.5	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	0.5 0.7 1.0	0.7 0.9 1.3	Ω	$ \begin{array}{l} V_{GS} = -4.5 V, \ I_D = -430 mA \\ V_{GS} = -2.5 V, \ I_D = -300 mA \\ V_{GS} = -1.8 V, \ I_D = -150 mA \end{array} $
Forward Transfer Admittance	Y _{fs}	_	-0.9	_	s	$V_{DS} = 10V, I_{D} = -250mA$
Diode Forward Voltage (Note 7)	V _{SD}	—	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}		59.76		pF	
Output Capacitance	C _{oss}		12.07		pF	V _{DS} = -16V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	6.36	—	pF	1 = 1.00012
Total Gate Charge	Qg	_	622.4			
Gate-Source Charge	Q _{gs}	—	100.3	—	рС	V _{GS} = -4.5V, V _{DS} = -10V, I _D = -250mA
Gate-Drain Charge	Q _{gd}	—	132.2	—		ID = -230IIIA
Turn-On Delay Time	t _{d(on)}	_	5.1			$V_{} = 10V_{-}V_{} = 4EV_{-}$
Turn-On Rise Time	tr	_	8.1	—	nS	$V_{DD} = -10V, V_{GS} = -4.5V,$ $R_{L} = 47\Omega, R_{G} = 10\Omega,$
Turn-Off Delay Time	t _{d(off)}	_	28.4	—	10	$R_{\rm L} = 4702, R_{\rm G} = 1002,$ $I_{\rm D} = -200 \text{mA}$
Turn-Off Fall Time	t _f	_	20.7	—		

Notes:

Device mounted on FR-4 PCB.
Short duration pulse test used to minimize self-heating effect.



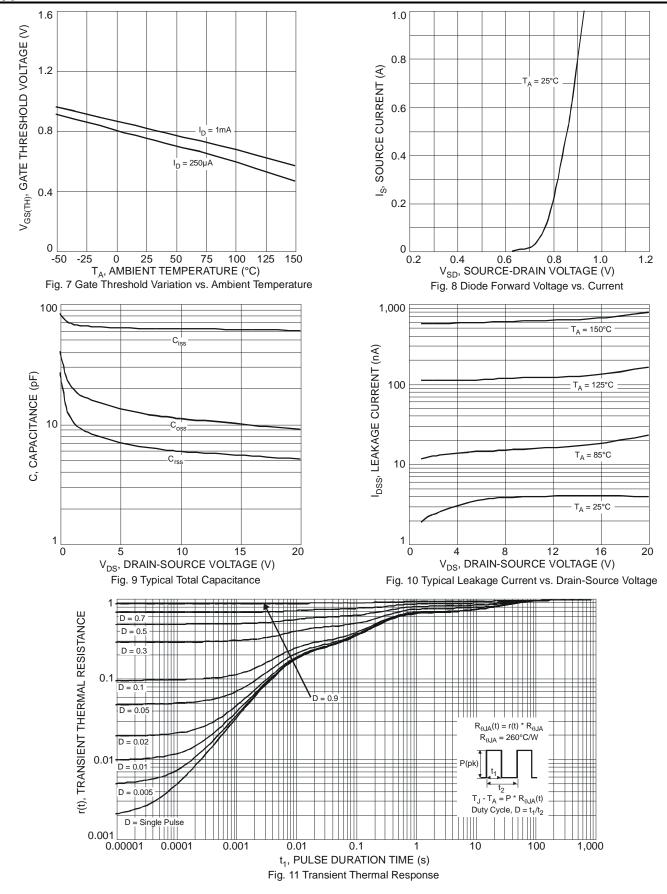
Typical Characteristics (Q1 N-Channel)



DMG1016VQ Document number: DS37972 Rev. 2 - 2

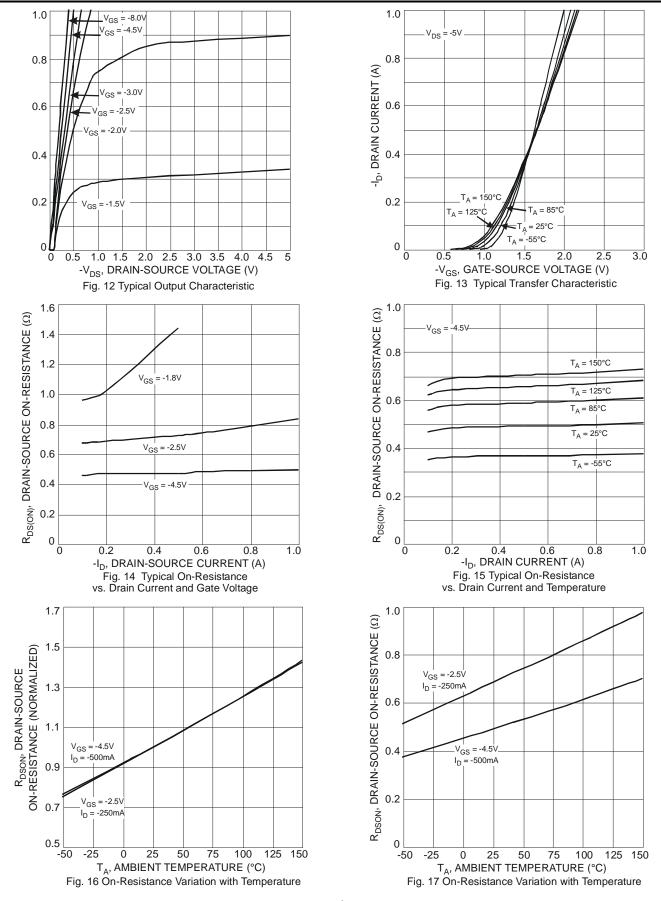


Typical Characteristics (Q1 N-Channel) (Continued)





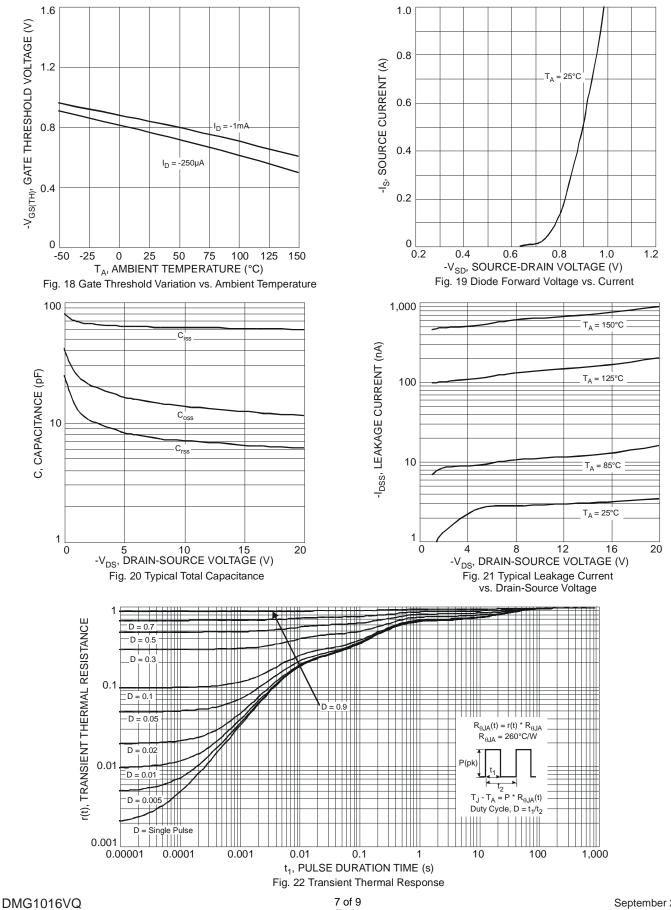
Typical Characteristics (Q2 P-Channel)



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Typical Characteristics (Q2 P-Channel) (Continued)

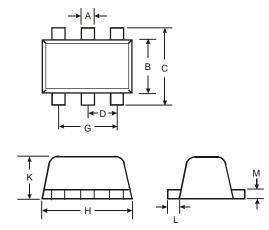




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

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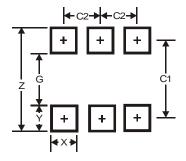


SOT-563					
Dim	Min	Max	Тур		
Α	0.15	0.30	0.20		
В	1.10	1.25	1.20		
С	1.55	1.70	1.60		
D			0.50		
G	0.90	1.10	1.00		
Н	1.50	1.70	1.60		
Κ	0.55	0.60	0.60		
L	0.10	0.30	0.20		
М	0.10	0.18	0.11		
All	Dimens	sions in	mm		

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

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Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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